### **Inductors**

# For High Frequency SMD

## MLG Series MLG1608 Type

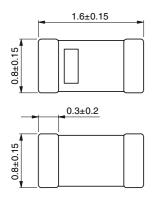
#### **FEATURES**

- Supports operating frequency bands of up to 10GHz with nominal inductance values from 1 to 100nH.
- · Provides high Q characteristics.
- Advanced monolithic structure is formed using a multilayering and sintering process with ceramic and conductive materials for high-frequency.

#### **APPLICATIONS**

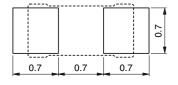
For high-frequency applications including mobile phones, portable phones, cordless phones, pagers and personal handy-phone systems (PHS).

#### **SHAPES AND DIMENSIONS**



Weight: 4mg

#### RECOMMENDED PC BOARD PATTERN

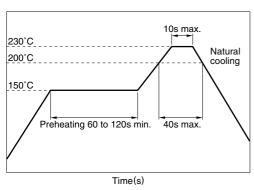




#### **SPECIFICATIONS**

Operating temperature range	–25 to +85°C
Storage temperature range	–40 to +85°C [Unit of products]

#### RECOMMENDED REFLOW SOLDERING CONDITIONS



#### PRODUCT IDENTIFICATION

MLG	1608	В	2N2	S	Т
(1)	(2)	(3)	(4)	(5)	(6)

(1) Series name

(2) Dimensions L×W	
1608	1.6×0.8mm

(3) Material code

#### (4) Inductance value

2N2	2.2nH
12N	12nH
39N	39nH

#### (5) Inductance tolerance

S	±0.3nH
D	±0.5nH
J	±5%

#### (6) Packaging style

Т	Taping (reel)	

#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	4000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
  The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 260°C. Soldering time should not exceed 3 seconds.

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0.7

0.75

0.8

0.9

300

300

300

300

For High Frequency SMD

Inductance	Inductance	Q	Test frequency	Self-resonant	DC resistance	Rated current	Part No.	
(nH)	tolerance	min.	L, Q (MHz)	frequency (GHz)mir	n. (Ω)max.	(mA)max.	rait No.	
1	±0.3nH	8	100	10	0.1	300	MLG1608B1N0S	
1.2	±0.3nH	8	100	10	0.1	300	MLG1608B1N2S	
1.5	±0.3nH	8	100	10	0.1	300	MLG1608B1N5S	
1.8	±0.3nH	8	100	9.8	0.1	300	MLG1608B1N8S	
2.2	±0.3nH	10	100	7.6	0.15	300	MLG1608B2N2S	
2.7	±0.3nH	10	100	7	0.15	300	MLG1608B2N7S	
3.3	±0.3nH	10	100	6.2	0.2	300	MLG1608B3N3S	
3.9	±0.3nH	10	100	5.6	0.2	300	MLG1608B3N9S	
4.7	±0.3nH	10	100	4.8	0.2	300	MLG1608B4N7S	
5.6	±0.5nH	10	100	4.6	0.2	300	MLG1608B5N6D	
6.8	±0.5nH	10	100	4.2	0.2	300	MLG1608B6N8D	
8.2	±0.5nH	10	100	3.6	0.25	300	MLG1608B8N2D	
10	±5%	12	100	3.2	0.25	300	MLG1608B10NJ	
12	±5%	12	100	2.8	0.3	300	MLG1608B12NJ	
15	±5%	12	100	2.6	0.35	300	MLG1608B15NJ	
18	±5%	12	100	2.4	0.4	300	MLG1608B18NJ	
22	±5%	12	100	2	0.5	300	MLG1608B22NJ	
27	±5%	12	100	1.9	0.55	300	MLG1608B27NJ	
33	±5%	12	100	1.6	0.6	300	MLG1608B33NJ	
39	±5%	12	100	1.4	0.65	300	MLG1608B39NJ	

1.2

0.9

8.0

0.7

47

56

68

82

100

Inductance Q: HP4291A+16193A SRF: HP8720C Rdc: YOKOGAWA TYPE7561

14

14

14

14

100

100

100

100

100

### TYPICAL ELECTRICAL CHARACTERISTICS

±5%

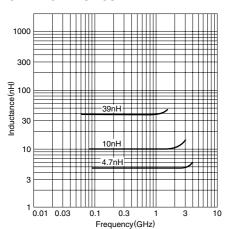
±5%

±5%

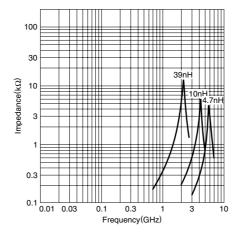
±5%

±5%

## INDUCTANCE vs. FREQUENCY CHARACTERISTICS



## IMPEDANCE vs. FREQUENCY CHARACTERISTICS



#### Q vs. FREQUENCY CHARACTERISTICS

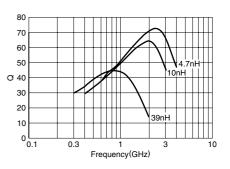
MLG1608B47NJ

MLG1608B56NJ

MLG1608B68NJ

MLG1608B82NJ

MLG1608BR10J



<sup>•</sup> Test equipment

<sup>•</sup> Rated current: Value obtained when current flows and temperature has risen to 20°C.